



XTMT15N70D

150V N-Channel MOSFET

Product Description

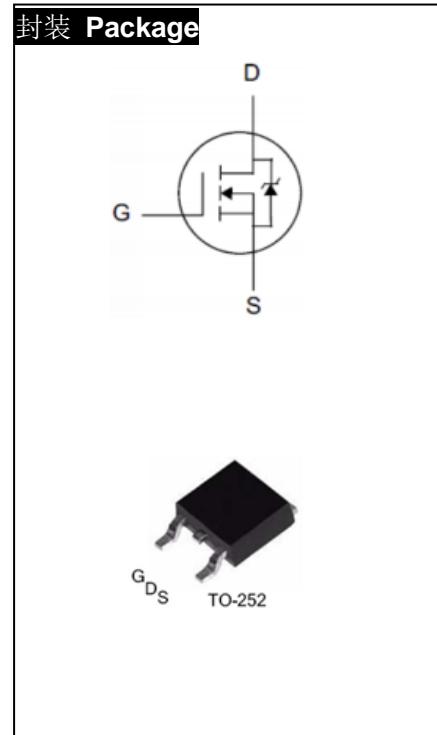
BV _{DSS}	150	V
I _D	70	A
R _{DSON} ,typ.	14	mΩ

General Features

- Proprietary New Planar Technology
- R_{DSON},typ.=14 mΩ@V_{GS}=10V
- Fast Recovery Body Diode
- Low Gate Charge Minimize Switching Loss

Applications

- Uninterruptible Power Supply
- Power Switching application



Device	Package	Marking
XTMT15N70D	TO-252	XTMT15N70D

Absolute Maximum Ratings T_j=25°C

Symbol	Parameter	Value	Unit
V _{DSS}	Drain-to-Source Voltage	150	V
V _{GSS}	Gate-to-Source Voltage	±20	
I _D	Continuous Drain Current	70	A
I _{DM}	Pulsed Drain Current at V _{GS} =10V	280	
E _{AS}	Single Pulse Avalanche Energy	500	mJ
P _D	Power Dissipation	310	W
	Derating Factor above 25°C	2.07	W/°C
T _L	Soldering Temperature Distance of 1.6mm from case for 10 seconds	300	°C
T _J &T _{STG}	Operating and Storage Temperature Range	-55 to 150	

Caution: Stresses greater than those listed in the "Absolute Maximum Ratings" may cause permanent damage to the device.



Thermal Characteristics

Symbol	Parameter	Value	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case	0.48	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	62.5	°C/W

Electrical Characteristics $T_j=25^\circ C$

OFF Characteristics

Symbol	Parameter	Min	Typ	Max	Unit	Test Condition
BV_{DSS}	Drain-to-Source Breakdown Voltage	150	-	-	V	$V_{GS}=0V, I_D=250\mu A$
I_{DSS}	Drain-to-Source Leakage Current	-	-	1	uA	$V_{DS}=150V, V_{GS}=0V$
		-	-	100		$V_{DS}=120V, V_{GS}=0V, T_J=125^\circ C$
I_{GSS}	Gate-to-Source Leakage Current	-	-	+100	nA	$V_{GS}=+20V, V_{DS}=0V$
		-	-	-100		$V_{GS}=-20V, V_{DS}=0V$

ON Characteristics

Symbol	Parameter	Min	Typ	Max	Unit	Test Condition
$R_{DS(ON)}$	Static Drain-to-Source On-Resistance	-	14	18	mΩ	$V_{GS}=10V, I_D=20A$
$V_{GS(TH)}$	Gate Threshold Voltage	2.0	3.0	3.6	V	$V_{DS}=V_{GS}, I_D=250\mu A$
g_{FS}	Forward Transconductance	50			S	$V_{DS}=5V, I_D=20A$

**Dynamic Characteristics**

Symbol	Parameter	Min	Typ	Max	Unit	Test Condition
C_{iss}	Input Capacitance	-	6644	-	pF	$V_{GS}=0V$, $V_{DS}=75V$, $f=1.0MHz$
C_{rss}	Reverse Transfer Capacitance	-	178	-		
C_{oss}	Output Capacitance	-	243	-		
R_G	Gate Series Resistance		1.7		Ω	$f=1.0MHz$
Q_g	Total Gate Charge	-	148	-	nC	$V_{DD}=75V$, $I_D=20A$, $V_{GS}=10V$
Q_{gs}	Gate-to-Source Charge	-	28	-		
Q_{gd}	Gate-to-Drain (Miller) Charge	-	50	-		

Resistive Switching Characteristics

Symbol	Parameter	Min	Typ	Max	Unit	Test Condition
$t_{d(ON)}$	Turn-on Delay Time	-	28	-	ns	$V_{DD}=75V$, $I_D=20A$, $V_{GS}=10V$ $R_g=2.5\Omega$
t_{rise}	Rise Time	-	30	-		
$t_{d(OFF)}$	Turn-Off Delay Time	-	95	-		
t_{fall}	Fall Time	-	40	-		

Source-Drain Body Diode Characteristics

Symbol	Parameter	Min	Typ	Max	Unit	Test Condition
I_{SD}	Continuous Source Current ^[1]	-	-	70	A	Integral pn-diode in MOSFET
I_{SM}	Pulsed Source Current ^[1]	-	-	280		
V_{SD}	Diode Forward Voltage	-	-	1.2	V	$I_S=20A$, $V_{GS}=0V$
t_{rr}	Reverse Recovery Time	-	40	-		
Q_{rr}	Reverse Recovery Charge	-	66	-	nC	$I_F=20A$, $dI_F/dt=100A/\mu s$

[1] Pulse width $\leq 380\mu s$; duty cycle $\leq 2\%$



Typical Characteristic

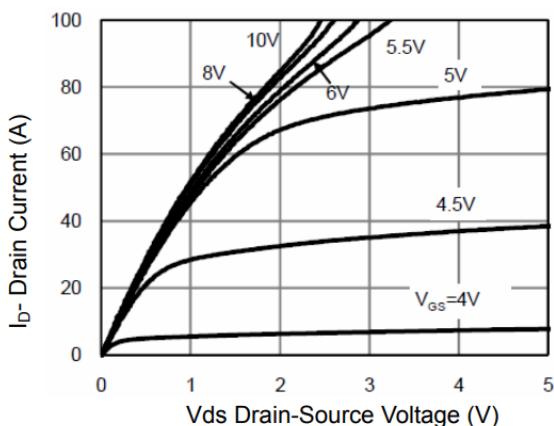


Figure 1 Output Characteristics

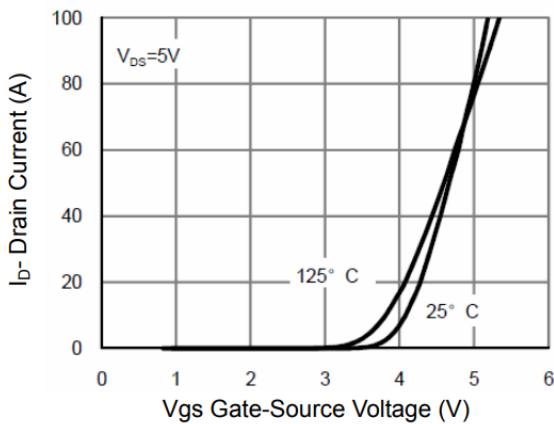


Figure 2 Transfer Characteristics

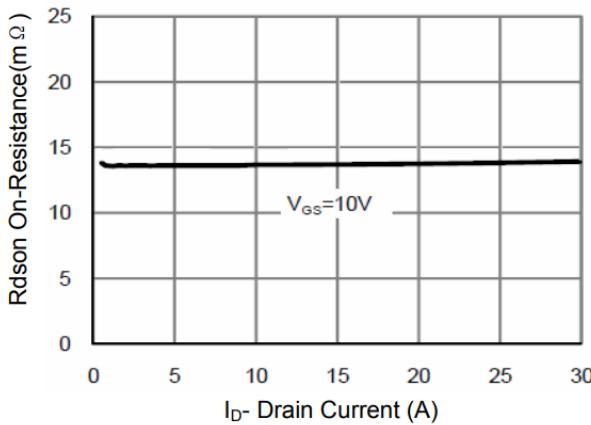


Figure 3 $R_{DS(on)}$ - Drain Current

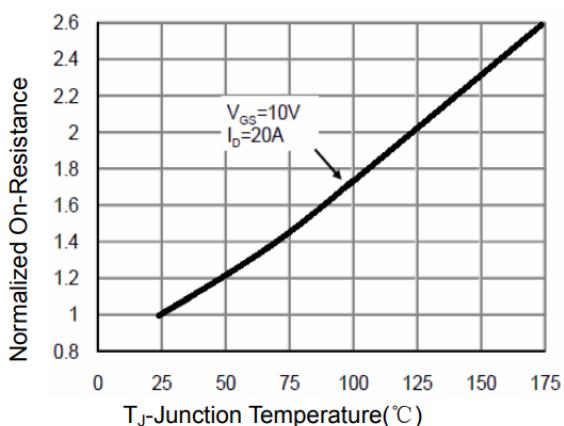


Figure 4 $R_{DS(on)}$ -Junction Temperature

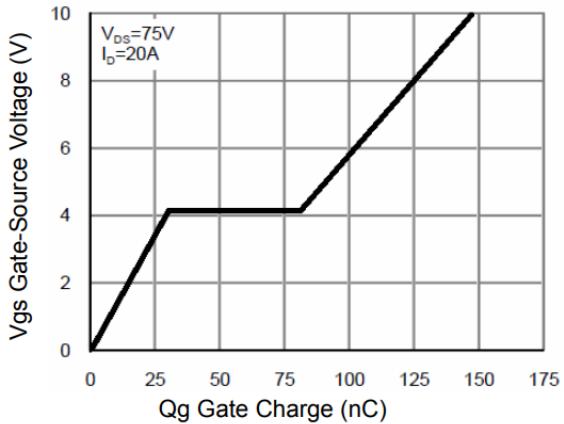


Figure 5 Gate Charge

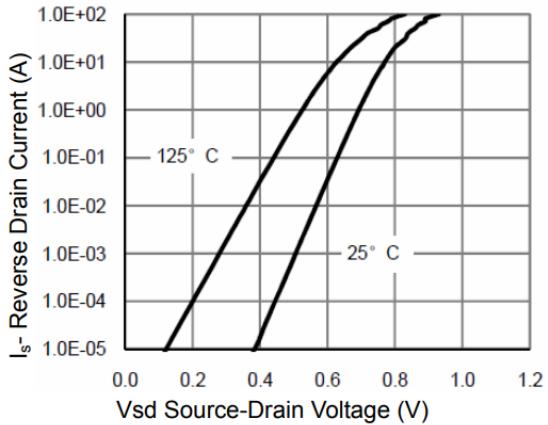


Figure 6 Source- Drain Diode Forward



Typical Characteristics(Cont.)

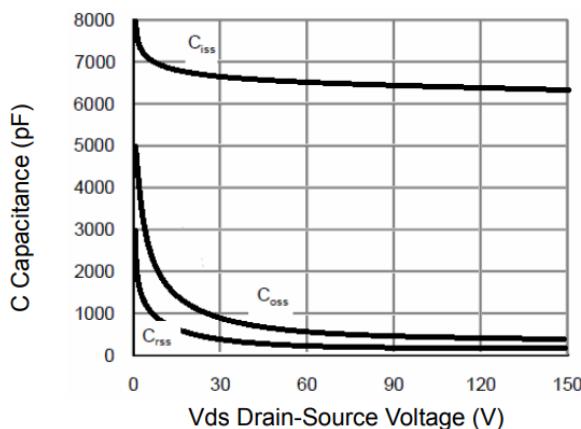


Figure 7 Capacitance vs Vds

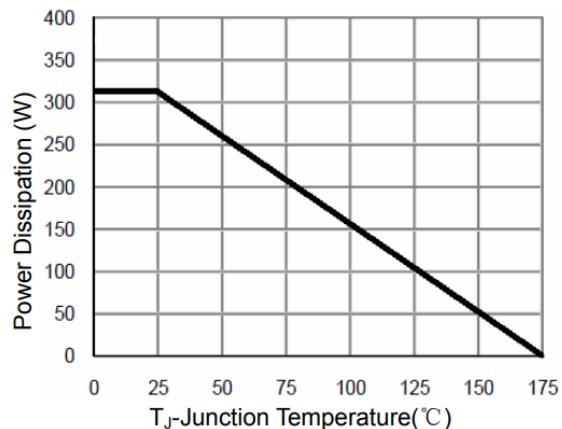


Figure 9 Power De-rating

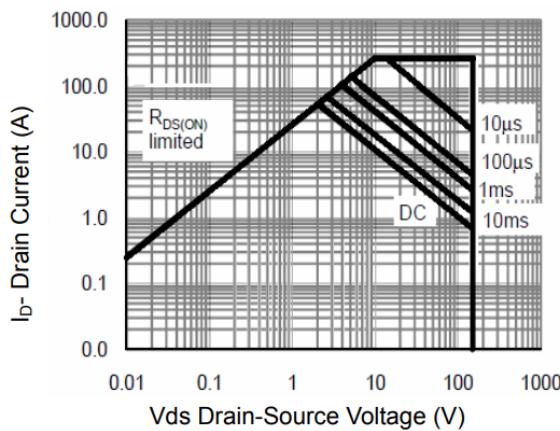


Figure 8 Safe Operation Area

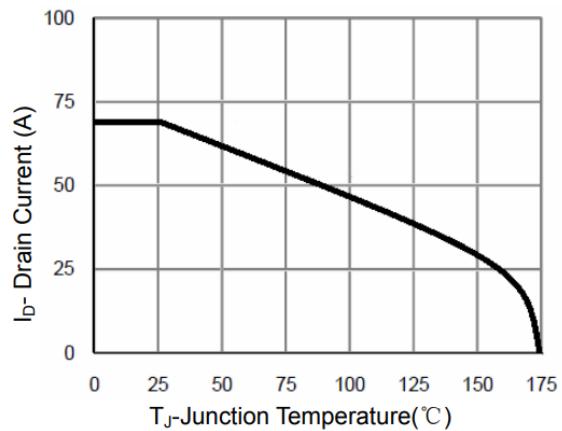


Figure 10 Current De-rating

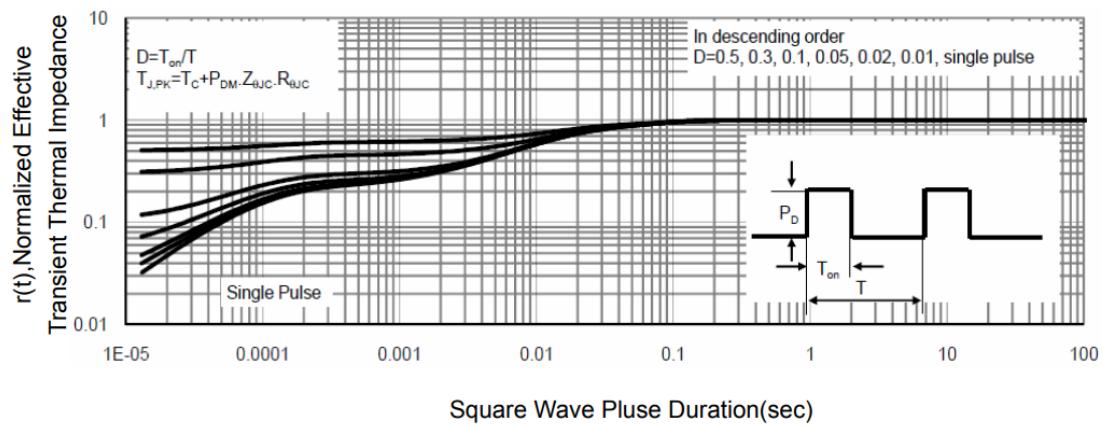


Figure 11 Normalized Maximum Transient Thermal Impedance



Test Circuits and Waveforms

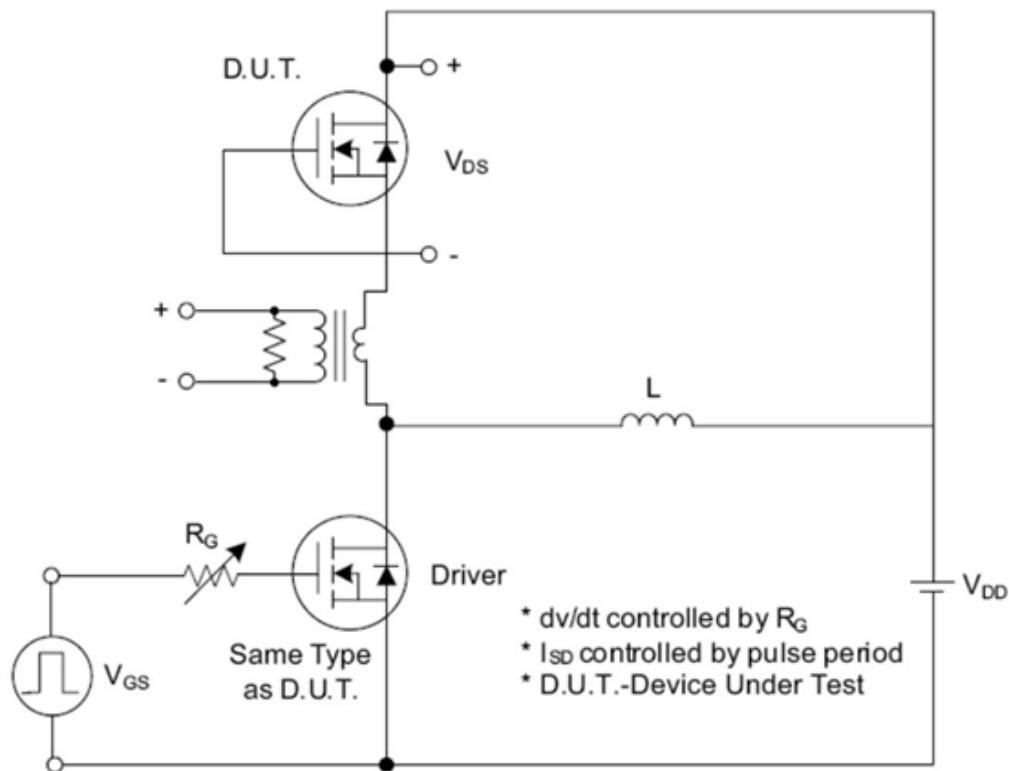


Fig. 1.1 Peak Diode Recovery dv/dt Test Circuit

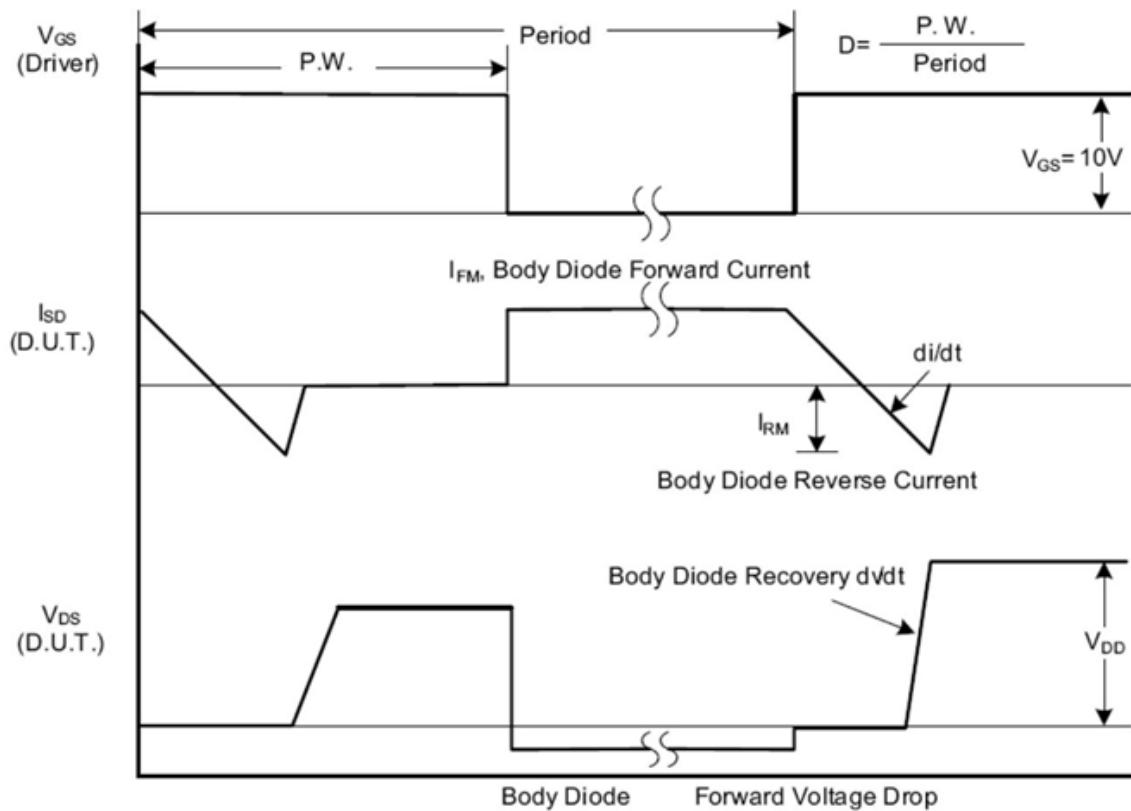


Fig. 1.2 Peak Diode Recovery dv/dt Waveforms



Test Circuits and Waveforms (Cont.)

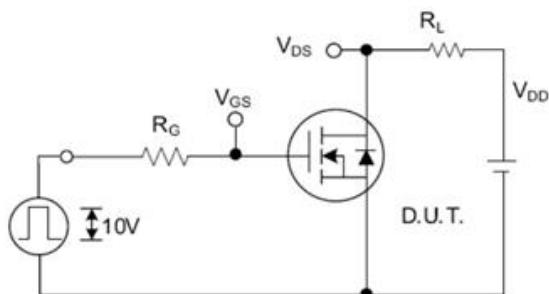


Fig. 2.1 Switching Test Circuit

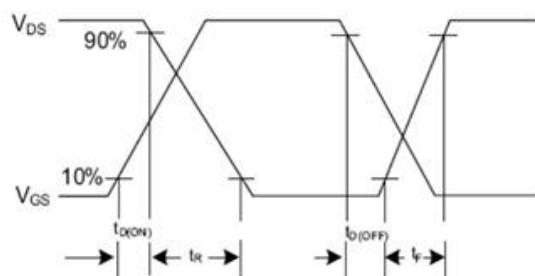


Fig. 2.2 Switching Waveforms

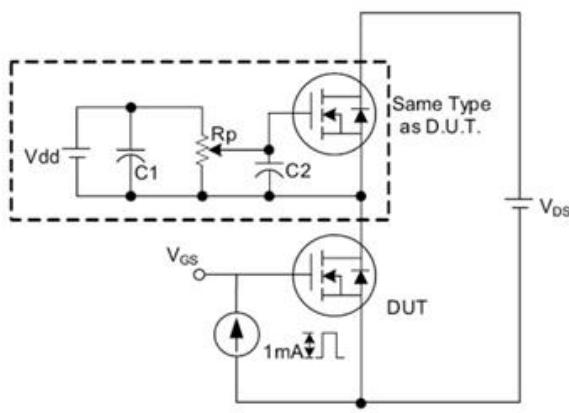


Fig. 3 . 1 Gate Charge Test Circuit

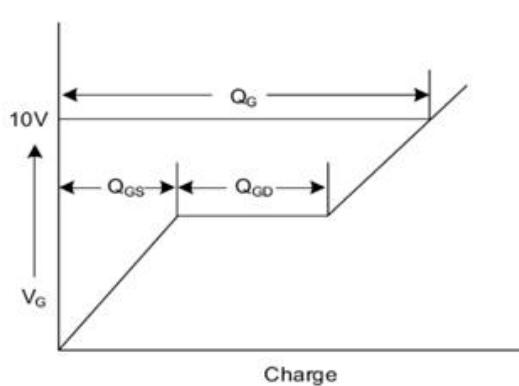


Fig. 3 . 2 Gate Charge Waveform

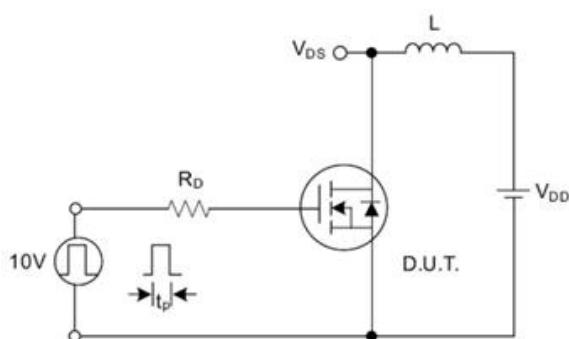


Fig. 4.1 Unclamped Inductive Switching Test Circuit

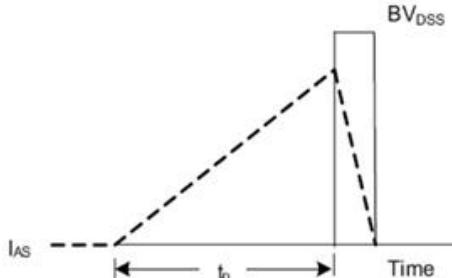


Fig. 4.2 Unclamped Inductive Switching Waveforms